5788797-2 - ACTIVE

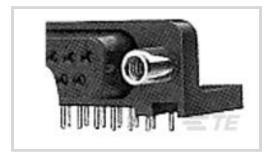
AMPLIMITE | AMPLIMITE HD-20

TE Internal #: 5788797-2 AMPLIMITE HD-20, PCB D-Sub Connectors, Receptacle, Board-to-Board, 9 Position, 2.74mm [.108in] Centerline, 2 Row, Row-to-Row Spacing 2.84 mm [.112 in]

View on TE.com >



Connectors > D-Shaped Connectors > D-Sub Connectors > PCB D-Sub Connectors > D-Sub Receptacle Assembly: Right Angle, Shell Size 1, 2.74mm



Connector & Housing Type: Receptacle

Connector System: Board-to-Board

Number of Positions: 9

Centerline (Pitch): 2.74 mm [.108 in]

Number of Rows: 2

All D-Sub Receptacle Assembly: Right Angle, Shell Size 1, 2.74mm (77)

Features

Product Type Features

Grounding Indents	Without
Grounding Straps	With

Footprint	8.08 mm[.318 in]
Shell Type	Front Metal Shell
Connector & Housing Type	Receptacle
Connector System	Board-to-Board
D-Sub Shell Size	1
Sealable	No
Connector & Contact Terminates To	Printed Circuit Board
Product Type	Connector
Configuration Features	
Number of Positions	9
Number of Rows	2
PCB Mount Orientation	Right Angle
Preloaded	Yes
Body Features	
Eyelet Material	Brass

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Eyelet Plating Material	Tin
Female Screwlock Material	Zinc
Plastic	No
Female Screwlock Plating Material	Clear Chromate
Connector Profile	Standard
Shell Plating Material	Tin
Shell Material	Steel
	.026 in
Contact Features	
Contact Mating Area Plating Material	Gold Flash
Contact Underplating Material	Nickel
PCB Contact Termination Area Plating Material	Tin
Contact Base Material	Copper Alloy
Contact Shape & Form	Round
Contact Current Rating (Max)	6 A
ermination Features	
Grounding Clips	Without
Termination Method to Printed Circuit Board	Through Hole - Solder
Termination Post Length	3.18 mm[.125 in]
Iechanical Attachment	
PCB Mount Alignment	With
Panel Mount Feature	Without
PCB Mount Retention	With
DCD Maximat Data atian Trus	Boardlock
PCB Mount Retention Type	
Mating Retention	With
	With Female Screwlocks, Fixed
Mating Retention	
Mating Retention Mating Retention Type	Female Screwlocks, Fixed
Mating Retention Mating Retention Type Connector Mounting Type	Female Screwlocks, Fixed Board Mount
Mating Retention Mating Retention Type Connector Mounting Type Boardlock Plating Material	Female Screwlocks, Fixed Board Mount Tin

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Centerline (Pitch)	2.74 mm[.108 in]
Housing Material	Thermoplastic
Housing Color	Black
Dimensions	
Row-to-Row Spacing	2.84 mm[.112 in]
PCB Thickness (Recommended)	1.57 mm[.062 in]
Usage Conditions	
High Temperature Housing	Yes
Operating Temperature Range	-55 – 105 °C[-67 – 221 °F]
Operation/Application	
Circuit Application	Signal
Industry Standards	
UL Flammability Rating	UL 94V-0
Packaging Features	
Packaging Method	Tray
r dekagnig metred	Пау

Product Compliance

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JAN 2021 (211) Candidate List Declared Against: JAN 2021 (211) Does not contain REACH SVHC
Halogen Content	Not Low Halogen - contains Br or Cl > 900 ppm.
Solder Process Capability	Wave solder capable to 265°C

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products

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will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-onreach

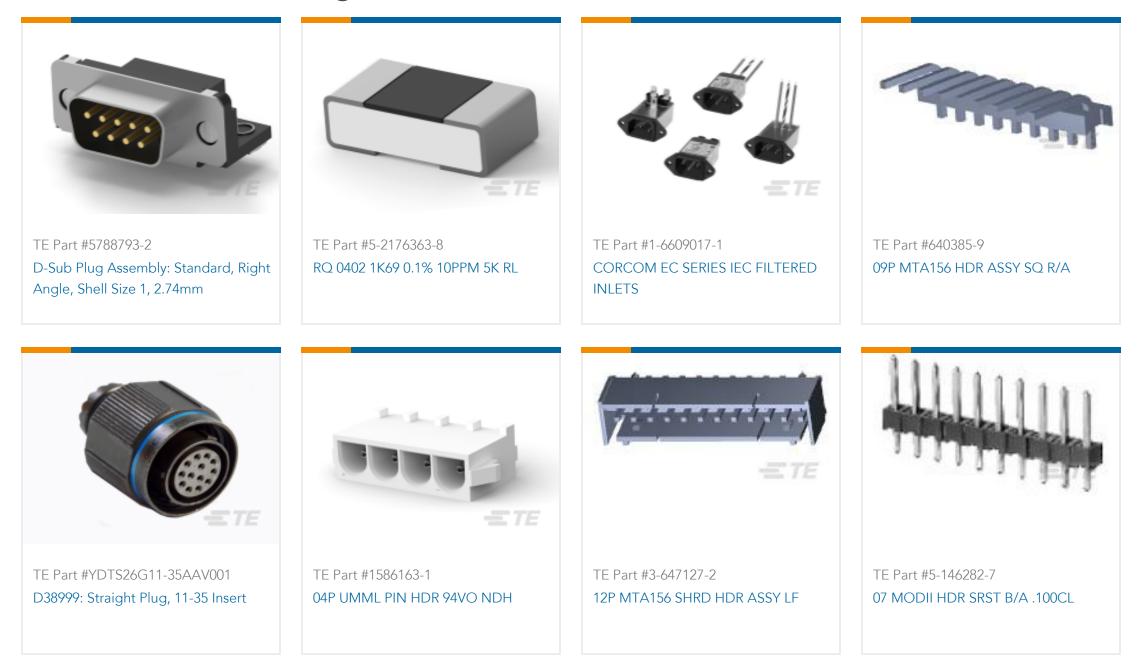
Compatible Parts



Also in the Series | AMPLIMITE HD-20

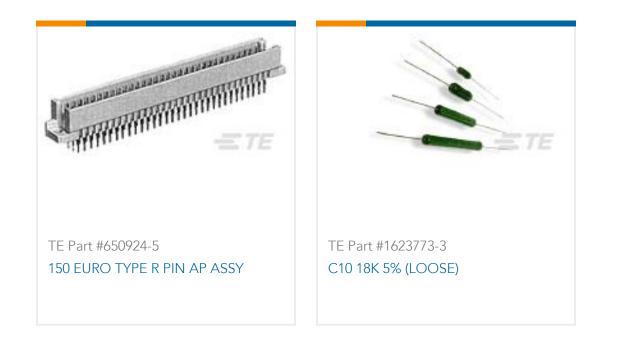


Customers Also Bought



AMPLIMITE HD-20, PCB D-Sub Connectors, Receptacle, Board-to-Board, 9 Position, 2.74mm [.108in] Centerline, 2 Row, Row-to-Row Spacing 2.84 mm [.112 in]





Documents

Product Drawings 09 HTMSFL ASSY RA 318 (SL,BL)

English

CAD Files

3D PDF

3D

Customer View Model

ENG_CVM_CVM_5788797-2_B.2d_dxf.zip

English

Customer View Model

ENG_CVM_CVM_5788797-2_B.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_5788797-2_B.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Datasheets & Catalog Pages AMPLIMITE Subminiature D Connectors - Right-Angle Posted Connectors

English

Product Specifications

Application Specification

English

Product Environmental Compliance

TE Material Declaration

English

Instruction Sheets

Instruction Sheet (U.S.)

English

Agency Approvals

UL Report

English

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